3.2x1.6mm SMD CHIP LED LAMP



ATTENTION
OBSERVE PRECAUTIONS
FOR HANDLING
ELECTROSTATIC
DISCHARGE
SENSITIVE
DEVICES

APTD3216MBC

BLUE

Features

- •3.2mmX1.6mm SMT LED, 1.8mm THICKNESS.
- •LOW POWER CONSUMPTION.
- •WIDE VIEWING ANGLE.
- •IDEAL FOR BACKLIGHT AND INDICATOR.
- •VARIOUS COLORS AND LENS TYPES AVAILABLE.
- •PACKAGE: 2000PCS / REEL .
- •RoHS COMPLIANT.

Description

The Blue source color devices are made with GaN on SiC Light Emitting Diode.

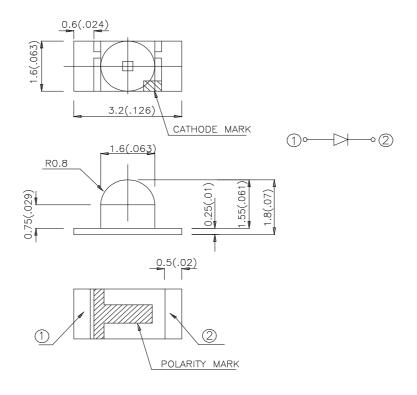
Static electricity and surge damage the LEDS.

It is recommended to use a wrist band or

anti-electrostatic glove when handling the LEDs.

All devices, equipment and machinery must be electrically grounded.

Package Dimensions



Notes:

- All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.2 (0.0079")$ unless otherwise noted.
- 3. Specifications are subject to change without notice.

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 APPROVED: J. Lu
 CHECKED: Allen Liu
 DRAWN: W.J.ZHU
 ERP:1203002234

Selection Guide

Part No.	Dice	Lens Type	Iv (mcd) @ 20mA		Viewing Angle
			Min.	Тур.	2 θ 1/2
APTD3216MBC	BLUE (GaN)	WATER CLEAR	18	45	40°

Note:

Electrical / Optical Characteristics at Ta=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Blue	430		nm	IF=20mA
λD	Dominant Wavelength	Blue	466		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Blue	60		nm	IF=20mA
С	Capacitance	Blue	100		pF	VF=0V;f=1MHz
VF	Forward Voltage	Blue	3.8	4.5	V	IF=20mA
IR	Reverse Current	Blue		10	uA	VR = 5V

Absolute Maximum Ratings at TA=25°C

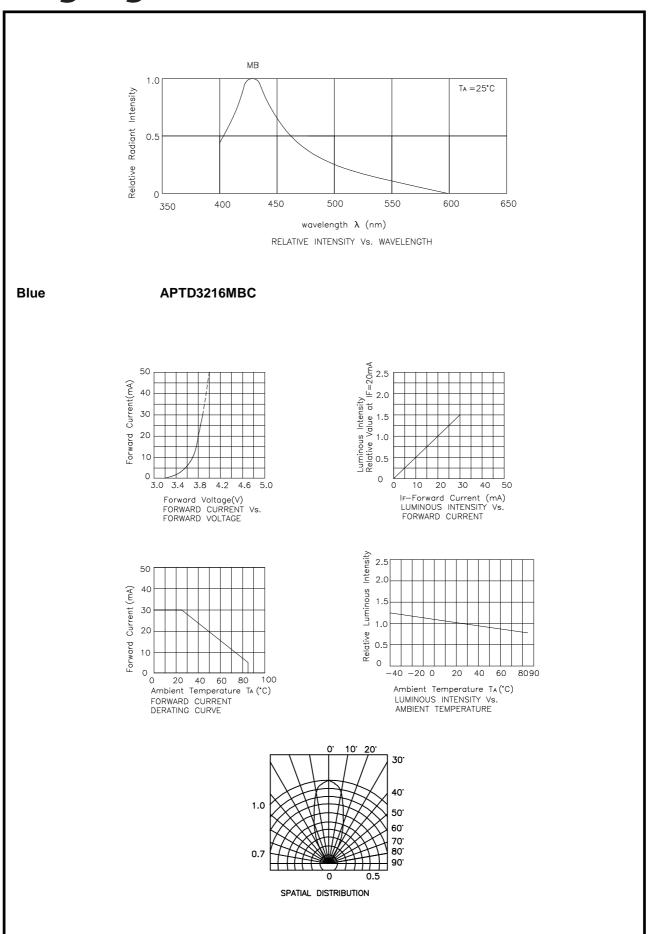
Parameter	Blue	Units	
Power dissipation	105	mW	
DC Forward Current	30	mA	
Peak Forward Current [1]	150	mA	
Reverse Voltage	5	V	
Operating / Storage Temperature	-40°C To +85°C		

Note:

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^{1.} θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.

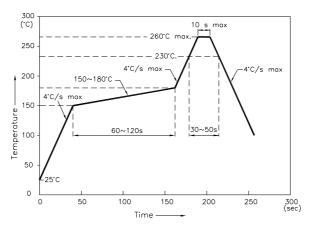
^{1. 1/10} Duty Cycle, 0.1ms Pulse Width.



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Reflow Soldering Profile For Lead-free SMT Process.

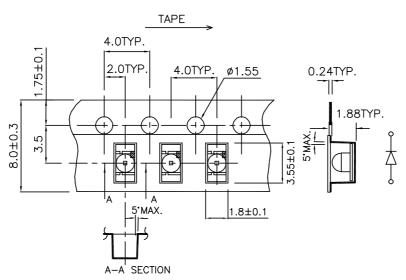


- NOTES: 1.We recommend the reflow temperature 245°C(\pm / \pm 5°C).The maximum soldering temperature should be limited to 260°C.
 - 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.
 - 3. Number of reflow process shall be 2 times or less.

Recommended Soldering Pattern (Units: mm)



Tape Specifications (Units:



Remarks:

If there is sorting requirement (eg. forward voltage, luminous intensity or wavelength), the condition as follows:

- 1. Wavelength: +/-1nm (Test condition is based on the sorting standard).
- 2.Luminous intensity: +/-15% (Test condition is based on the sorting standard).
- 3. Forward voltage: +/-0.1V (Test condition is based on the sorting standard).

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